

0.5A, 600V N-CHANNEL POWER MOSFET

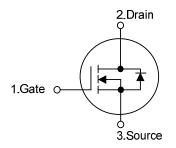
DESCRIPTION

The UTC **1N60A** is a high voltage MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)}$ < 15 Ω @V_{GS} = 10V.
- * Ultra Low gate charge (typical 8.0nC)
- * Low reverse transfer capacitance (C_{RSS} = 3.0 pF(max))
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

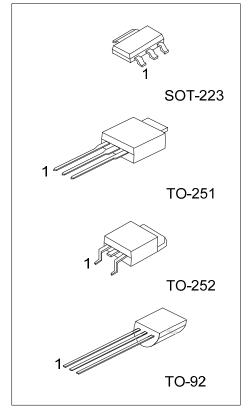
SYMBOL



ORDERING INFORMATION

Ordering Number		Deelvere	Pin Assignment			Decking	
Lead Free	Halogen Free	Package 1 2		3	Packing		
1N60AL-AA3-R	1N60AG-AA3-R	SOT-223	G	D	S	Tape Reel	
1N60AL-TM3-T	1N60AG-TM3-T	TO-251	G	D	S	Tube	
1N60AL-TN3-R	1N60AG-TN3-R	TO-252	G	D	S	Tape Reel	
1N60AL-T92-B	1N60AG-T92-B	TO-92	G	D	S	Таре Вох	
1N60AL-T92-K	1N60AG-T92-K	TO-92 G D S			Bulk		
Note: Pin Assignment: G: Gate D: Drain S: Source							
1N60AL-AA3-R (1)Packing Type (2)Package Type (3)Lead Free (1) B: Tape Box, K: Bulk, R: Tape Reel, T: Tube (2) AA3: SOT-223, TM3: TO-251, TN3: TO-252 T92: TO-92 (3) L: Lead Free, G: Halogen Free					-		

Power MOSFET



MARKING INFORMATION

PACKAGE	MARKING				
SOT-223	1N60A → G: Halogen Free → Data Code				
TO-251 TO-252	UTC 1N60A G: Halogen Free Lot Code 1 Lot Code				
TO-92	UTC 1N60A P: Halogen Free Data Code				



PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V _{DSS}	600	V	
Gate-Source Voltage		V _{GSS}	±30	V	
Continuous Drain Current		I _D	0.5	А	
Pulsed Drain Current (Note 2)		I _{DM}	2	А	
Avalanche Energy	Single Pulse(Note 3)	E _{AS}	50	mJ	
	Repetitive(Note 2)	E _{AR}	3.6	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns	
Power Dissipation (T _C =25°C)	SOT-223	PD	6.25		
	TO-251/TO-252		34	W	
	TO-92		3		
Derate above 25°C	SOT-223		0.05		
	TO-251/TO-252		0.27	W/°C	
	TO-92		0.025		
Junction Temperature	Inction Temperature		+150	°C	
Operating Temperature		T _{OPR}	-55 ~ +150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified.)

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature

3. L=92mH, I_{AS}=0.8A, V_{DD}=50V, R_G=0 Ω , Starting T_J=25°C

4. $I_{SD} \leq 1.0A$, di/dt $\leq 100A/\mu s$, $V_{DD} \leq BV_{DSS}$, Starting T_J=25°C

THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT	
Junction to Ambient	SOT-223		150	°C/W	
	TO-251/TO-252	θ _{JA}	110		
	TO-92		160		
Junction to Case	SOT-223	θ _{JC}	20	°C/W	
	TO-251/TO-252		5		
	TO-92		80		



■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified.)

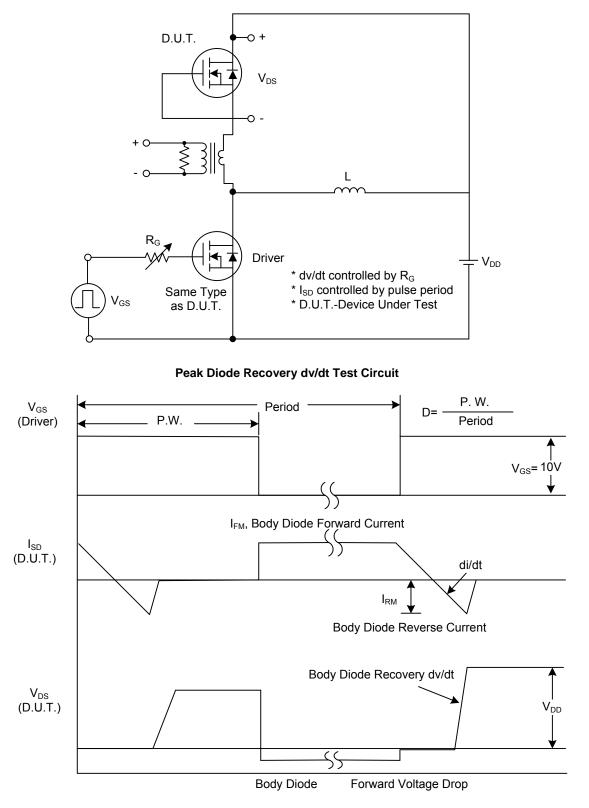
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS		•				
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D = 250µA	600			V
Drain-Source Leakage Current (TJ=25°C)	- I _{DSS}				10	
Drain-Source Leakage Current (T _J =125°C)		$V_{DS} = 600V, V_{GS} = 0V$			10	μA
Gate-Source Leakage Current Forward Reverse	I _{GSS}	$V_{GS} = 30V, V_{DS} = 0V$ $V_{GS} = -30V, V_{DS} = 0V$			100 -100	nA nA
Breakdown Voltage Temperature Coefficient	∆BV _{DSS} /∆T _J	I _D = 250μA referenced to 25°C		0.4		V/°C
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V_{DS} = V_{GS} , I_D = 250 μ A	2.0		4.5	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 0.5A		11	15	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ISS}				100	рF
Output Capacitance	C _{oss}	V _{DS} =25V, V _{GS} =0V, f=1MHz			20	рF
Reverse Transfer Capacitance	C _{RSS}	<u> </u>			3	рF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{D (ON)}			12	34	ns
Turn-On Rise Time	t _R	V_{DD} =300V, I_{D} =0.5A, R_{G} =5 Ω		11	32	ns
Turn-Off Delay Time	t _{D (OFF)}	(Note 1,2)		40	90	ns
Turn-Off Fall Time	t _F			18	46	ns
Total Gate Charge	Q _G	V _{DS} =480V, V _{GS} =10V, I _D =0.8A		8	10	nC
Gate-Source Charge	Q _{GS}	(Note 1,2)		1.8		nC
Gate-Drain Charge	Q_{GD}			4.0		nC
SOURCE- DRAIN DIODE RATINGS AND (CHARACTERIS	ȘTICS		·		
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _{SD} = 1.2A			1.6	V
Maximum Continuous Drain-Source Diode					1.2	А
Forward Current	I _S				1.2	~
Maximum Pulsed Drain-Source Diode	I _{SM}				4.8	А
Forward Current	'SM				ч.U	
Reverse Recovery Time	t _{RR}	V _{GS} =0V, I _{SD} = 1.2A		136		ns
Reverse Recovery Charge	Q _{RR}	di/dt = 100A/µs		0.3		μC

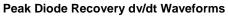
Notes: 1. Pulse Test: Pulse Width≤300µs, Duty Cycle≤2%

2. Essentially independent of operating temperature.



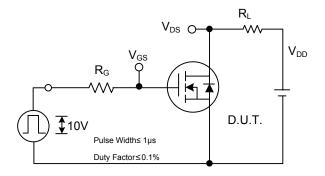
TEST CIRCUITS AND WAVEFORMS

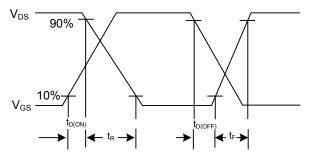




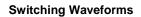


■ TEST CIRCUITS AND WAVEFORMS (Cont.)





Switching Test Circuit



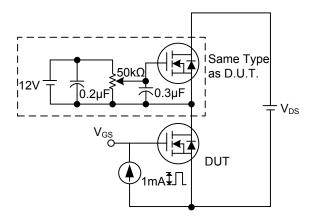
 Q_G

Q_{GD}

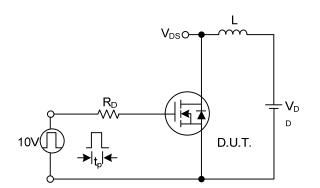
10V

 V_{GS}

Q_{GS}-



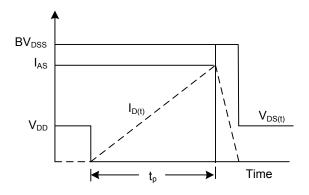
Gate Charge Test Circuit



Unclamped Inductive Switching Test Circuit

Gate Charge Waveform

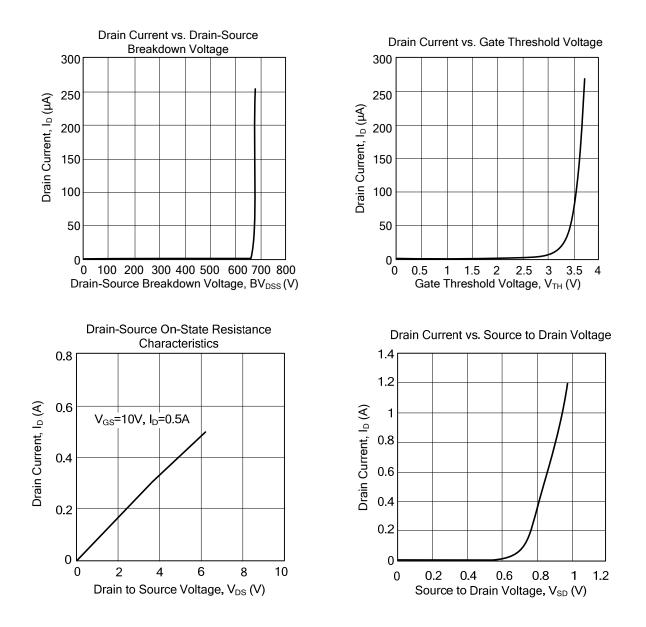
Charge







TYPICAL CHARACTERISTICS



UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice.

